

AMENDMENTS TO SPECIFICATION

Please amend the following paragraphs as indicated by the marked-up versions set forth below.:

Page 5, line 22 to Page 6, line 1:

The circuit space converter **20** comprises a ~~multiplayer~~multilayer ceramic substrate (MLC) **21**, which has multiple layers of circuits arranged therein, ~~and~~ contacts 65 disposed at the top side, and contacts 66 disposed at the bottom-sides side, ~~the contacts 65,66 being disposed at~~ predetermined locations and respectively electrically connected to the circuits. Subject to the arrangement of the multiple layers of circuits, the density of the contacts 65 at the top side is higher than the density of contacts 66 at the bottom side.

Page 6, lines 4-8:

Step I: Formation of probe holders **22** on the top of the MLC **21**. As shown in FIG. 6, probe holders **22** are formed of high hardness, for example, Ni-Co on the topside of the MLC **21** at the respective circuit contacts 65 by means of LIGA (Lithography process), and then a bonding layer **23** is formed of tin lead alloy on the probe holders **22** by means of electroplating for the bonding of the probes **10**.